

#7/B  
Halsey  
11/7/02

Docket No.: 1614.1142

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Shunji BABA

Serial No. 09/811,605

Group Art Unit: 1762

Confirmation No. 9323

Filed: March 20, 2001

Examiner: Brian K. Talbot

For: RESIN COATING METHOD (AS AMENDED)

AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

CERTIFICATE UNDER 37 CFR 1.3(a)  
I hereby certify that this correspondence is being de-  
posited with the United States Postal Service as first  
class mail in an envelope addressed to: Commissioner  
of Patents and Trademarks, Washington, D.C. 20231  
on 9-15  
STAAS & HALSEY  
By: B. Halsey  
Date: 11-7-02

This is in response to the Office Action mailed April 15, 2002, and having a period for  
response set to expire on July 15, 2002.

The following amendments and remarks are respectfully submitted. Reconsideration of  
the claims is respectfully requested.

IN THE TITLE:

Please AMEND the Title as follows: Title - RESIN COATING METHOD--.

IN THE CLAIMS:

Please AMEND the following claims:

1. (ONCE AMENDED) A resin coating method for applying resin to a  
predetermined amount of resin region of on a printed wiring board, comprising the steps of:  
applying a resin on a printed wiring board;  
spreading said resin on said printed wiring board by a centrifugal force; and  
imaging an external appearance of the resin extruded from a resin application device;

and